L	Hits	Search Text	DB	Time stamp
Number	:		Ì	1
1	·268		USPAT;	2004/05/11
		identif\$7 or detect\$3))	US-PGPUB;	15:53
			EPO; JPO;	
			DERWENT	
2	14		USPAT;	2004/05/11 .
		(recogni\$5 or identif\$7 or detect\$3)))	US-PGPUB;	15:52
			EPO; JPO;	
			DERWENT	
3	67	1 ,	USPAT;	2004/05/11
		(recogni\$5 or identif\$7 or detect\$3))	US-PGPUB;	15:54
			EPO; JPO;	
	_		DERWENT	
4	2	(, (USPAT;	2004/05/11
		(recogni\$5 or identif\$7 or detect\$3))))	US-PGPUB;	15:53
		and ((semiconductor near6 wafer near6 ID	EPO; JPO;	
		near6 (recogni\$5 or identif\$7 or	DERWENT	
		detect\$3)))		
5	3906		USPAT;	2004/05/11
		or label) near6 (recogni\$5 or identif\$7	US-PGPUB;	15:54
		or detect\$3))	EPO; JPO;	
			DERWENT	
7	115	382/\$.ccls. and ((wafer near6 (ID or mark	USPAT;	2004/05/11
		or information or label) near6 (recogni\$5	US-PGPUB;	15:54
		or identif\$7 or detect\$3)))	EPO; JPO;	
	000	Annual con Newton and Con	DERWENT	0000,407,407
	808	(semiconductor near6 wafer near6 (ID or	USPAT;	2004/05/11
		information or mark\$3 or label\$3) near6	US-PGPUB;	15:55
		(recogni\$5 or identif\$7 or detect\$3))	EPO; JPO;	
8	32	202/6	DERWENT	2004/05/11
0	34	,	USPAT;	2004/05/11
		wafer near6 (ID or information or mark\$3	US-PGPUB;	15:55
		or label\$3) near6 (recogni\$5 or identif\$7 or detect\$3)))	EPO; JPO;	
-	2		DERWENT	2004/05/11
	2	(0324290).PN.	USPAT;	2004/05/11
			US-PGPUB; EPO; JPO;	11:08
			DERWENT	
-	2	("20020021837").PN.	USPAT;	2004/05/11
	2	(2002002103 /).FN.	USPAT; US-PGPUB;	15:51
			EPO; JPO;	13.31
			DERWENT	
			DEKMENT	L